


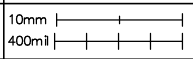
ASSEMBLY NOTES:

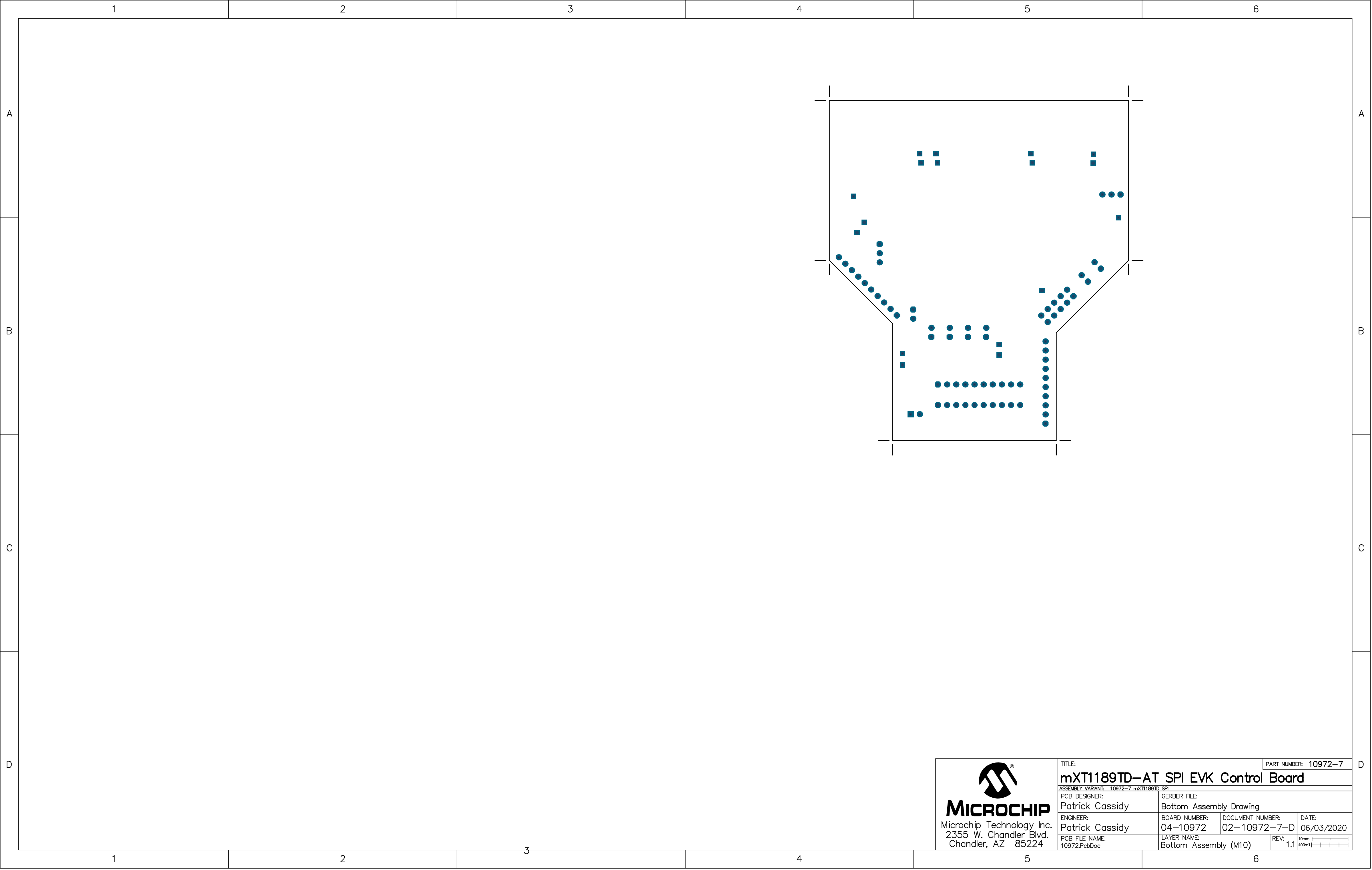
- 1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
- 2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
- 3. ALL TEST POINT THROUGH HOLES (DENOTED TPxx) SHALL BE FREE OF SOLDER.
- 4. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
- 5. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
- 6. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm.
- 7. PLACE LABELS ON THE LOCATION INDICATED.

REV	ECO	Comments	Date
A0	N/A	First Issue	21st Jan 2015
B0	N/A	Inserted blanks in place of device ID	27th Aug 2015
B1	N/A	Changed to MCHP branding	11th July 2017
B2	N/A	Added RoHS, WEEE & CE symbols	8th Mar 2018
1	N/A	Q1, U3, U5 now MCHP parts Board number changed per Dev Tools ATM	7th Mar 2019



Microchip Technology Inc.  
2355 W. Chandler Blvd.  
Chandler, AZ 85224

TITLE: <b>mXT1189TD—AT SPI EVK Control Board</b>				PART NUMBER: 10972—7	
PCB DESIGNER: Patrick Cassidy				GERBER FILE: Top Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04—10972	DOCUMENT NUMBER: 02—10972—7—D	DATE: 06/03/2020	
PCB FILE NAME: 10972.PcbDoc		LAYER NAME: Top Assembly (M11)		REV: 1.1	



TITLE:		PART NUMBER: 10972-7	
mXT1189TD-AT SPI EVK Control Board			
ASSEMBLY VARIANT: 10972-7 mXT1189TD SPI			
PCB DESIGNER: Patrick Cassidy		GERBER FILE: Bottom Assembly Drawing	
ENGINEER: Patrick Cassidy		BOARD NUMBER: 04-10972	DOCUMENT NUMBER: 02-10972-7-D
PCB FILE NAME: 10972.PcbDoc		LAYER NAME: Bottom Assembly (M10)	DATE: 06/03/2020
		REV: 1.1	10mm 400mil

